

## Voltage Detectors , ME2801 Series

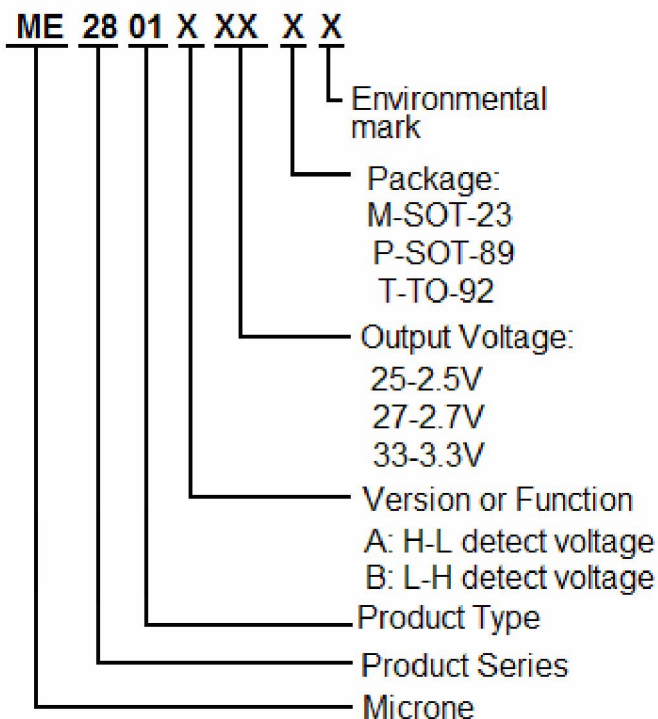
### General Description

**ME2801 Series** are highly precise , low power consumption voltage detectors,manufactured using CMOS technologies. Detect voltage is extremely accurate with minimal temperature drift.CMOS output configurations are available.

### Features

- | Highly accuracy :  $\pm 1\%$
- | Low power consumption : TYP 0.7uA ( $V_{in}=1.5V$ )
- | Detect voltage range : 2.0V~4.8V in 0.1V increments
- | Operating voltage range : 0.7V~7V
- | Detect voltage temperature characteristics :  
TYP $\pm 100$ ppm/
- | Output configuration : CMOS
- | Package : SOT-23-3 , SOT-89-3 , TO-92

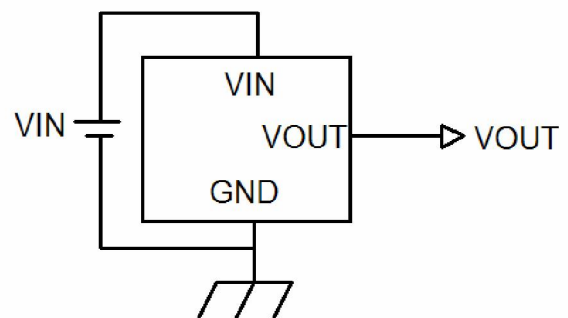
### Selection Guide



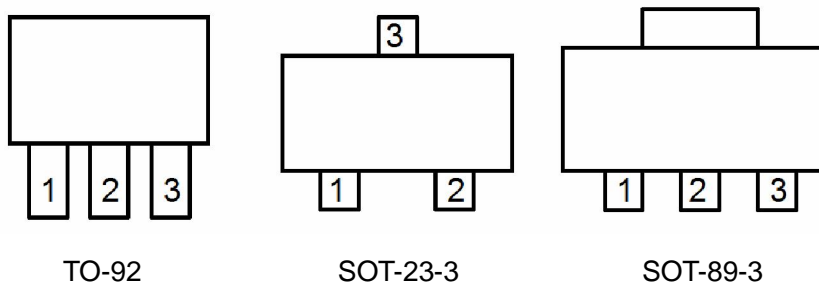
### Typical Application

- | Microprocessor reset circuitry
- | Memory battery back-up circuits
- | Power-on reset circuits
- | Power failure detection

### Typical Application Circuit



## Pin Configuration

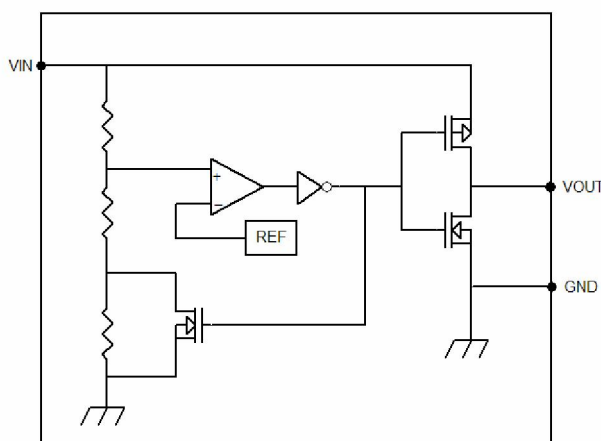


## Pin Assignment

ME2801AXX/ME2801BXX

Pin Number				Pin Name	Functions
SOT-23-3	SOT-89-3	TO-92(T)	TO-92(T1)		
2	3	3	2	GND	Ground
1	1	1	3	VOUT	Output Voltage
3	2	2	1	VIN	Input Voltage

## Block Diagram



## Absolute Maximum Ratings

PARAMETER	SYMBOL	RATINGS	UNITS
$V_{IN}$ Input Voltage	$V_{IN}$	8	V
Output Current	$I_{out}$	50	mA
Output Voltage	CMOS	$V_{out}$	$V_{ss}-0.3 \sim V_{in}+0.3$
	N-ch open drain		$V_{ss}-0.3 \sim 12$
Continuous Total Power Dissipation	SOT-23-3	$P_d$	150
	SOT-89-3		500
	TO-92		300
Operating Ambient Temperature	$T_{Opr}$	-40~+85	
Storage Temperature	$T_{stg}$	-40~+125	
Soldering temperature and time	$T_{solder}$	260 , 10s	

## Electrical Characteristics

( $V_{DF(S)}=2.0V$  to  $4.8V\pm 1\%$ ,  $T_a=25^{\circ}C$ , unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
VDF	Detect Voltage		$VDF(S)*0.99$	VDF(S)	$VDF(S)*1.01$	V
VHYS	Hysteresis Range		$VDF*0.02$	$VDF*0.05$	$VDF*0.08$	V
Iss	Supply Current	Vin=1.5V	-	0.7	2.7	uA
		Vin=2.0V	-	0.8	3.2	
		Vin=3.0V	-	0.9	3.6	
		Vin=4.0V	-	1.0	3.8	
		Vin=5.0V	-	1.1	4.3	
VIN	Operating Voltage	$VDF(T)=1.6V$ to $6.0V$	0.7	-	7	V
IOUT	Output Current	N-ch , VDS=0.5V VIN=1.0V =2.0V =3.0V =4.0V =5.0V	1.0 3.0 5.0 6.0 7.0	2.2 7.7 10.1 11.5 13.0		mA
		P-ch , VDS=2.1V VIN=8.0V		-10.0	-2.0	mA
$VDF/(topr*VDF)$	Temperature characteristics	-40 Topr 85		$\pm 100$		ppm/

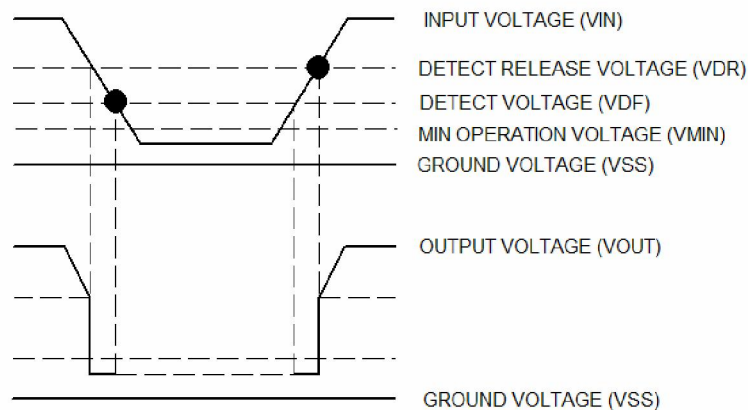
- Note :
- 1、VDF(S) : Specified Detection Voltage value
  - 2、VDF : Actual Detection Voltage value
  - 3、Release Voltage :  $VDR=VDF+VHYS$  (ME2801A 系列)  
 $VDR=VDF-VHYS$  (ME2801B 系列)

## Functional Description :

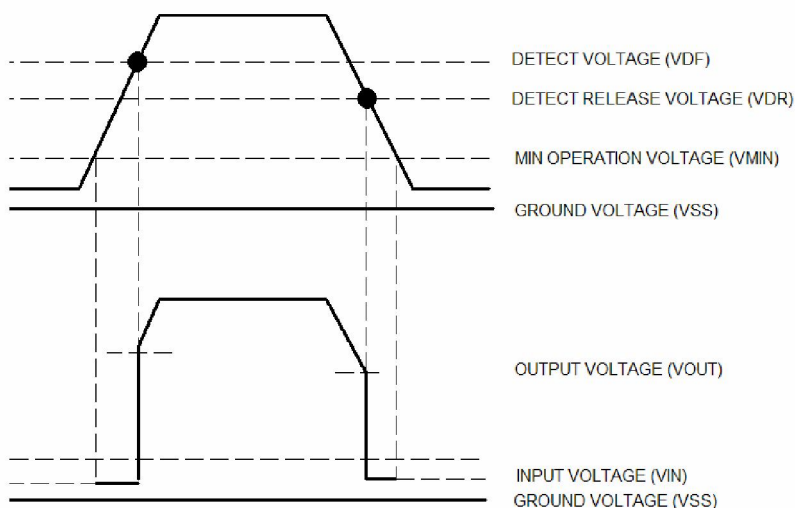
- 1、 When input voltage ( $V_{IN}$ ) rises above detect voltage ( $V_{DF}$ ), output voltage ( $V_{OUT}$ ) will be equal to  $V_{IN}$ .
- 2、 When input voltage ( $V_{IN}$ ) falls below detect voltage ( $V_{DF}$ ), output voltage ( $V_{OUT}$ ) will be equal to the ground voltage ( $V_{SS}$ ) level.
- 3、 When input voltage ( $V_{IN}$ ) falls to a level below that of the minimum operating voltage ( $V_{MIN}$ ), output will become unstable. In this condition,  $V_{IN}$  will equal the pulled-up output ( should output be pulled-up.)
- 4、 When input voltage ( $V_{IN}$ ) rises above the ground voltage ( $V_{SS}$ ) level, output will be unstable at levels below the minimum operating voltage ( $V_{MIN}$ ). Between the  $V_{MIN}$  and detect release voltage ( $V_{DR}$ ) levels, the ground voltage ( $V_{SS}$ ) level will be maintained.
- 5、 When input voltage ( $V_{IN}$ ) rises above detect release voltage ( $V_{DR}$ ), output voltage ( $V_{OUT}$ ) will be equal to  $V_{IN}$ .
- 6、 The difference between  $V_{DR}$  and  $V_{DF}$  represents the hysteresis range.

## Timing Chart :

### ME2801AXX:



### ME2801BXX:



## Directions for use :

- 1、 Please use this IC within the stated maximum ratings. Operation beyond these limits may cause degrading or permanent damage to the device.
- 2、 When a resistor is connected between the  $V_{IN}$  pin and the input with CMOS output configurations, oscillation may occur as a result of voltage drops at  $R_{IN}$  if load current( $I_{OUT}$ ) exists.(refer to the Oscillation Description(1) below)
- 3、 When a resistor is connected between the  $V_{IN}$  pin and the input with CMOS output configurations, oscillation may occur as a result of through current at the time of voltage release even if load current( $I_{OUT}$ ) does not exist. (refer to the Oscillation Description(2) below)
- 4、 With a resistor connected between the  $V_{IN}$  and the input, detect and release voltage will rise as a result of the IC's supply current flowing through the  $V_{IN}$  pin.
- 5、 In order to stabilize the IC's operations, please ensure that  $V_{IN}$  pin's input frequency's rise and fall times are more than several  $\mu$  Sec/V.

## Oscillation Description :

- 1、 Output current oscillation with the CMOS output configuration

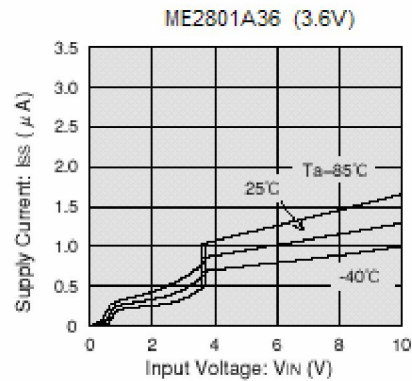
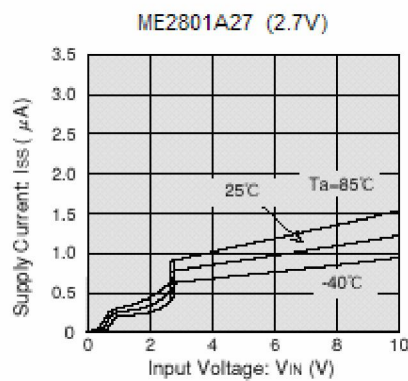
When the voltage applied at IN rises, release operations commence and the detector's output voltage increase. Load current( $I_{OUT}$ ) will flow at  $R_L$ . Because a voltage drop( $R_{IN} * I_{OUT}$ ) is produced at the  $R_{IN}$  resistor, located between the input(IN) and the  $V_{IN}$  pin. The load current will flow via the IC's pin. The voltage drop will also lead to a fall in the voltage level at the  $V_{IN}$  pin. When the  $V_{IN}$  pin voltage level falls below the detect voltage level, detect operations will commence. Following detect operations, load current flow will cease and since voltage drop at  $R_{IN}$  will disappear, the voltage level at the  $V_{IN}$  pin will rise and release operations will begin over again. Oscillation may occur with this "release-detect-release" repetition. Further, this condition will also appear via means of a similar mechanism during detect operations.

- 2、 Oscillation as a result of through current

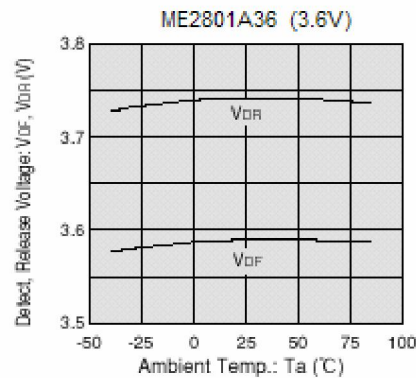
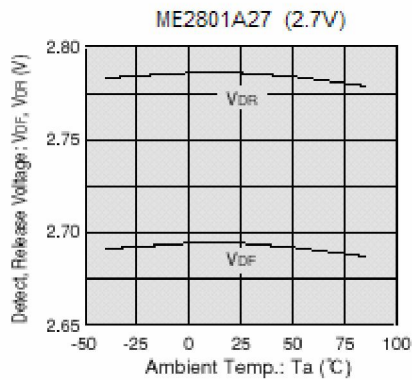
Since the ME2801 series are CMOS IC's, through current will flow when the IC's internal circuit switching operates(during release and detect operations). Consequently, oscillation is liable to occur as a result of drops in voltage at the through current's resistor( $R_{IN}$ ) during release voltage operations.(refer to diagram 2) since hysteresis exists during detect operations, oscillation is unlikely to occur.

## Type Characteristics

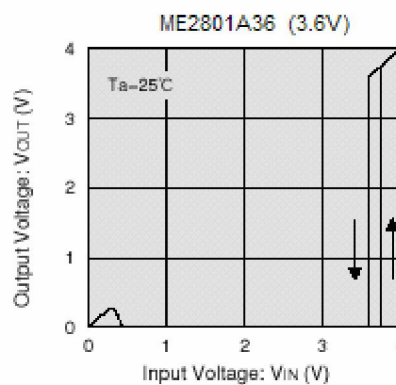
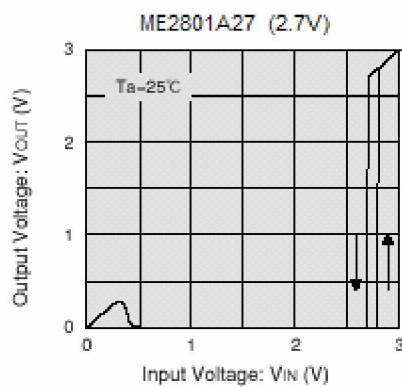
### 1、 SUPPLY CURRENT VS. INPUT VOLTAGE



### 2、 DETECT,RELEASE VOLTAGE VS. AMBIENT TEMPERATURE

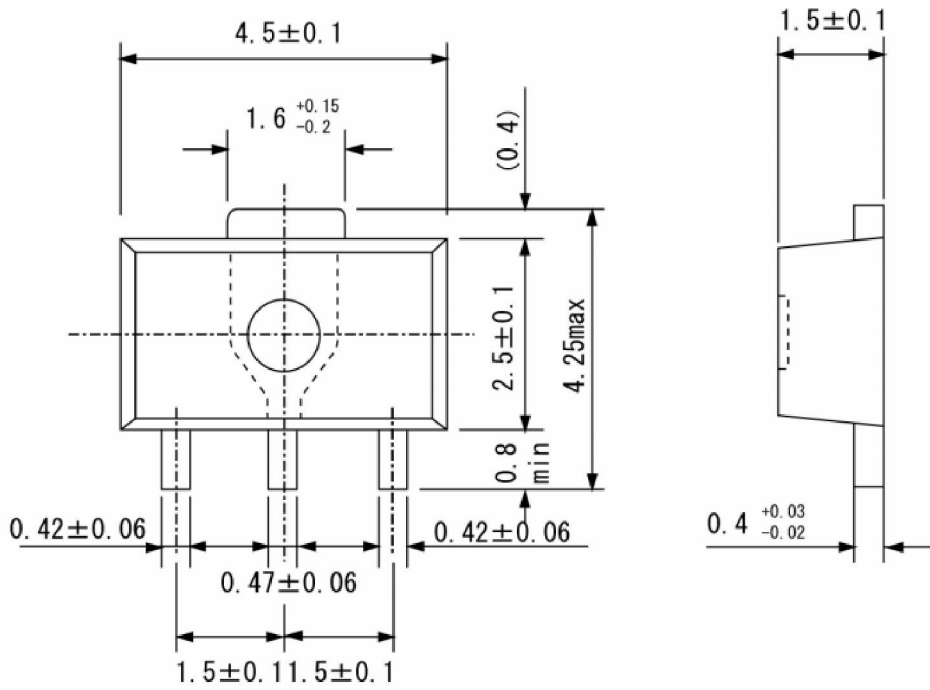


### 3、 OUTPUT VOLTAGE VS. INPUT VOLTAGE

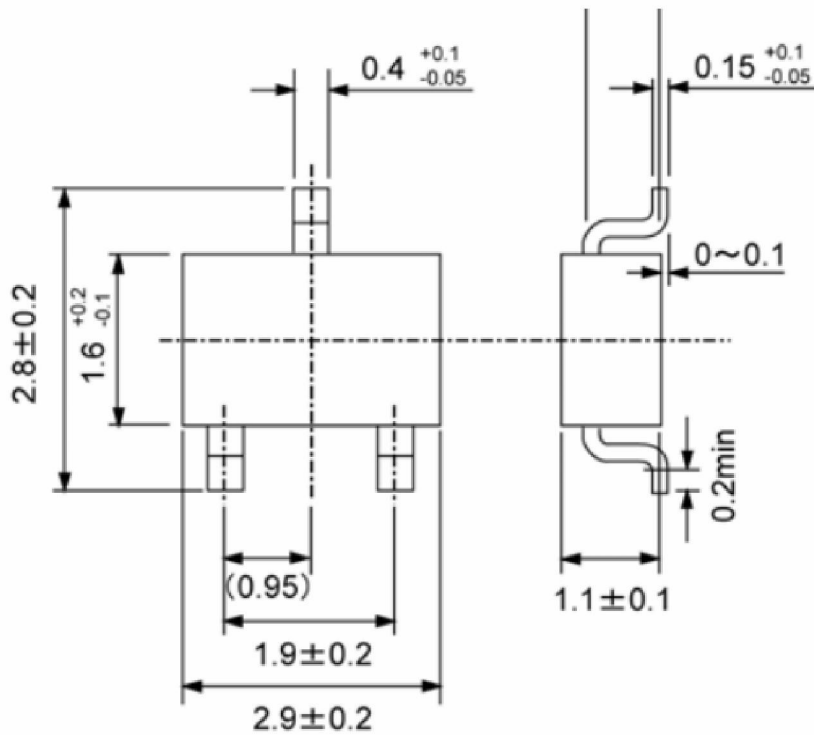


Package Information

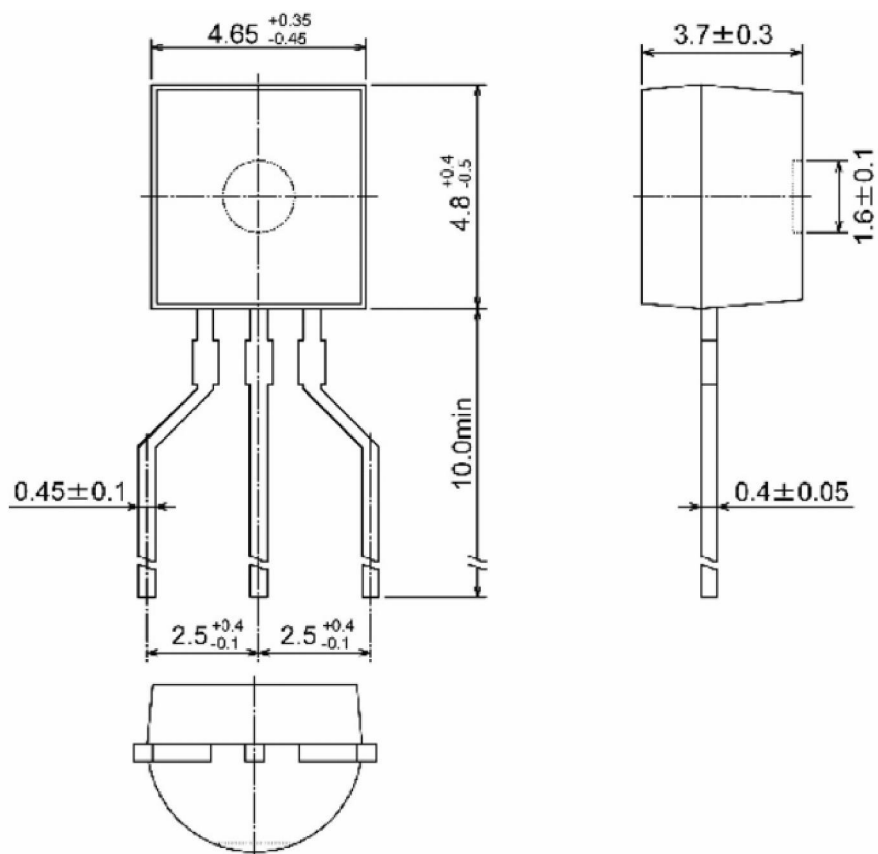
· SOT-89-3



· SOT-23-3



· TO-92





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